

## **STP52N25M5**

# N-channel 250 V, 0.055 $\Omega$ 28 A, TO-220 MDmesh<sup>TM</sup> V Power MOSFET

#### **Features**

Туре	V <sub>DSS</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub>
STP52N25M5	250 V	< 0.065 Ω	28 A

- Amongst the best R<sub>DS(on)</sub>\* area
- High dv/dt capability
- Excellent switching performance
- Easy to drive
- 100% avalanche tested

#### **Application**

■ Switching applications

#### **Description**

This devices is an N-channel MDmesh™ V Power MOSFET based on an innovative proprietary vertical process technology, which is combined with STMicroelectronics' well-known PowerMESH™ horizontal layout structure. The resulting product has extremely low onresistance, which is unmatched among siliconbased Power MOSFETs, making it especially suitable for applications which require superior power density and outstanding efficiency.

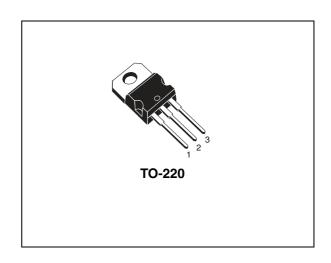


Figure 1. Internal schematic diagram

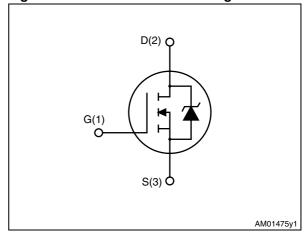


Table 1. Device summary

Order code	Marking	Package	Packaging
STP52N25M5	52N25M5	TO-220	Tube

Contents STP52N25M5

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STP52N25M5 Electrical ratings

# 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
$V_{GS}$	Gate- source voltage 25		V
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25 °C	28	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	18	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	112	
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	110	
I <sub>AR</sub>	Avalanche current, repetitive or not-repetitive (pulse width limited by T <sub>J</sub> max)	10	
E <sub>AS</sub>	Single pulse avalanche energy (starting $T_J = 25$ °C, $I_D = I_{AR}$ , $V_{DD} = 50$ V)	230	
dv/dt <sup>(2)</sup>	Peak diode recovery voltage slope	15	
T <sub>J</sub> T <sub>stg</sub>	-55 to 150		°C

<sup>1.</sup> Pulse width limited by safe operating area.

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	1.14	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-pcb max	62.5	°C/W
T <sub>J</sub>	Maximum lead temperature for soldering purpose	300	°C/W

<sup>2.</sup>  $I_{SD} \leq 28 \text{ A, di/dt} \leq 400 \text{ A/µs, } V_{Peak} < V_{(BR)DSS}$ .

Electrical characteristics STP52N25M5

# 2 Electrical characteristics

(Tcase =25°C unless otherwise specified).

Table 4. On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	I <sub>D</sub> = 1 mA, V <sub>GS</sub> = 0	250			V
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	$V_{DS}$ = Max rating $V_{DS}$ = Max rating, $T_{C}$ =125 °C			1 100	μ <b>Α</b> μ <b>Α</b>
I <sub>GSS</sub>	Gate-body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ± 25 V			100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 100 \mu A$	3	4	5	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 14 A		0.055	0.065	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 50 \text{ V, f} = 1 \text{ MHz,}$ $V_{GS} = 0$	-	1770 110 17	-	pF pF pF
C <sub>o(er)</sub> <sup>(1)</sup>	Equivalent output capacitance energy related	$V_{GS} = 0, V_{DS} = 0 \text{ to } 80\%$ $V_{(BR)DSS}$	-	93	-	pF
C <sub>o(tr)</sub> <sup>(2)</sup>	Equivalent output capacitance time related	$V_{GS} = 0, V_{DS} = 0 \text{ to } 80\%$ $V_{(BR)DSS}$	-	178	-	pF
Rg	Gate input resistance	f=1 MHz open drain	-	2	-	Ω
Qg	Total gate charge	V <sub>DD</sub> = 200 V, I <sub>D</sub> = 28 A,		47		nC
$Q_{gs}$	Gate-source charge	V <sub>GS</sub> = 10 V	-	10	-	nC
$Q_{gd}$	Gate-drain charge	(see Figure 14)		24		nC

<sup>1.</sup>  $C_{o(er)}$  is a constant capacitance value that gives the same stored energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$ .

<sup>2.</sup>  $C_{o(tr)}$  is a constant capacitance value that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$ .

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
$t_{\text{d(V)}} \\ t_{\text{r(V)}} \\ t_{\text{f(i)}} \\ t_{\text{c(off)}}$	Voltage delay time Voltage rise time Current fall time Crossing time	$V_{DD} = 125 \text{ V}, I_{D} = 14 \text{ A},$ $R_{G} = 4.7 \Omega, V_{GS} = 10 \text{ V}$ (see Figure 13)		40 18 64 82	-	ns ns ns ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
I <sub>SD</sub>	Source-drain current Source-drain current (pulsed)		-		28 112	A A
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> = 28 A, V <sub>GS</sub> = 0	-		1.6	V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD}$ = 28 A, di/dt = 100 A/µs $V_{DD}$ = 60 V, $T_{J}$ = 25 °C (see Figure 15)	-	168 1.2 14.5		ns μC A
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD}$ = 28 A, di/dt = 100 A/µs $V_{DD}$ = 60 V T <sub>J</sub> = 150 °C (see Figure 15)	-	196 1.7 17		ns μC A

<sup>1.</sup> Pulse width limited by safe operating area.

<sup>2.</sup> Pulsed: pulse duration = 300  $\mu$ s, duty cycle 1.5%

Electrical characteristics STP52N25M5

#### 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

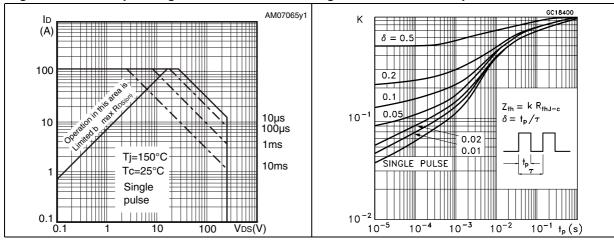


Figure 4. Output characteristics

Figure 5. Transfer characteristics

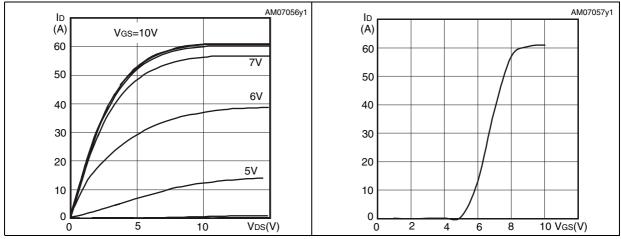


Figure 6. Gate charge vs gate-source voltage Figure 7. Static drain-source on resistance

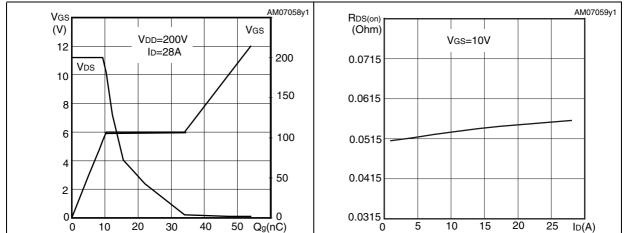


Figure 8. **Capacitance variations** 

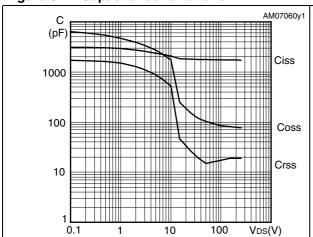


Figure 9. Output capacitance stored energy

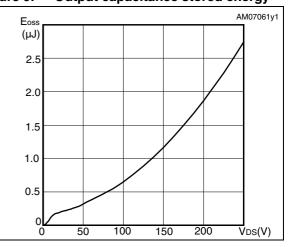
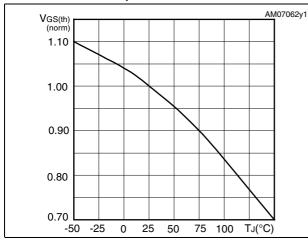


Figure 10. Normalized gate threshold voltage Figure 11. Normalized on resistance vs vs temperature

temperature



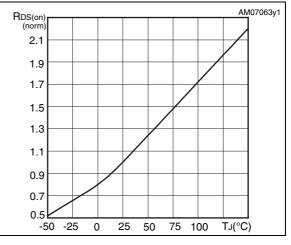
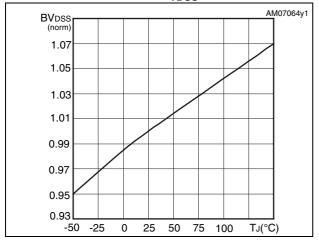


Figure 12. Normalized B<sub>VDSS</sub> vs temperature



Test circuits STP52N25M5

## 3 Test circuits

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

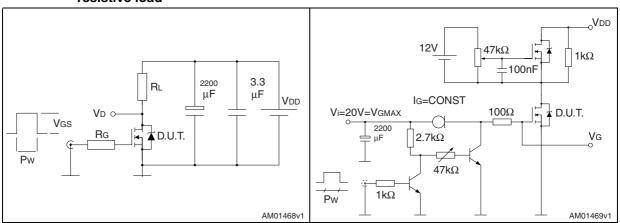


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped inductive load test circuit

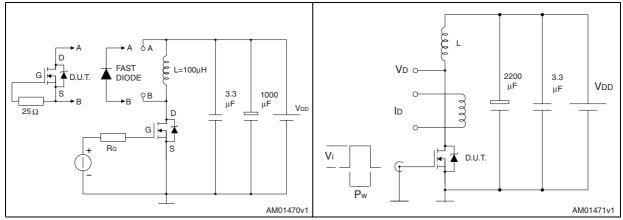
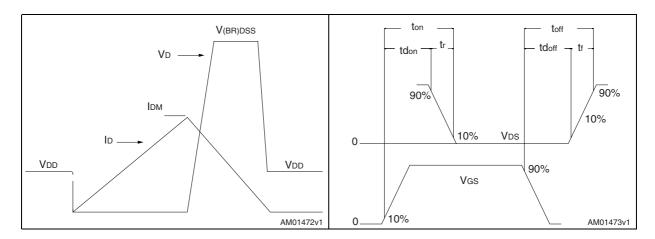


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



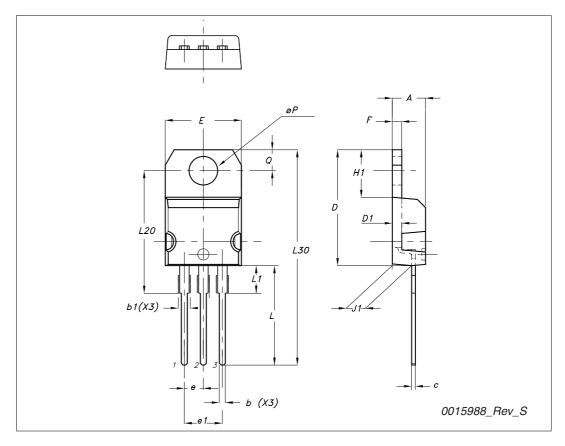
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# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

<b>TO-220</b>	type	A me	chanic	al data
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Dim		mm	
Dim	Min	Тур	Max
A	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
С	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
ØP	3.75		3.85
Q	2.65		2.95



STP52N25M5 Revision history

# 5 Revision history

Table 8. Document revision history

Date	Revision	Changes
29-Jul-2010	1	First release

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